

# QSFP-DD 400G LR8 10 km (OM9660LS100) Databrief

#### **Product Features**

- QSFP-DD MSA compliant
- Compliant to IEEE 802.3cn 400GBASE-LR8
- Digital diagnostic monitoring support
- Hot pluggable 76 pin electrical interface
- 8 LAN-WDM lanes MUX/DEMUX design
- 53.125 Gbps PAM4 Channel Electrical Serial Interface (400GAUI-8)
- Maximum power consumption 14.5 W
- LC duplex connector
- Supports 425 Gbps bit rate
- Up to 10 km transmission on single mode fiber
- Operating case temperature: 0°C to 70°C
- Single 3.3 V power supply
- RoHS 2 compliant

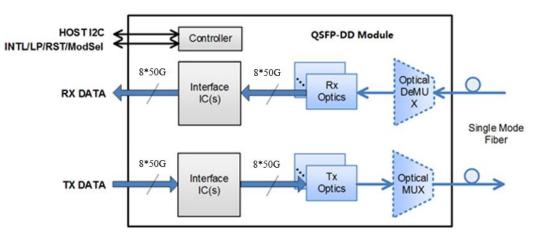
### **Applications**

- 400GBASE-LR8 Ethernet
- Telecom networking
- Data Center Interconnect



## **1. Function Description**

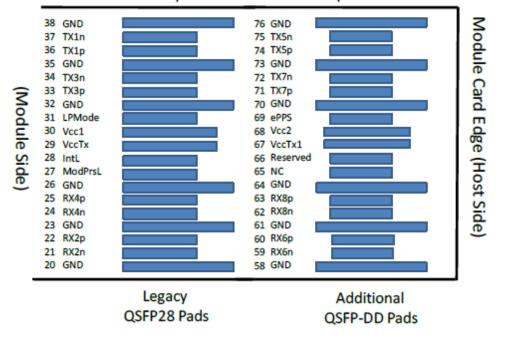
Hisilicon's OM9660LS100 module are designed for 10 km optical communication applications, and it is compliant to IEEE 802.3cn for 400GE Ethernet. This module contains 8-lane optical transmitter, 8-lane optical receiver and module management block including 2 wire serial interfaces. The optical signals are multiplexed to a single-mode fiber through an industry standard LC connector. A block diagram is shown in Figure 1-1.



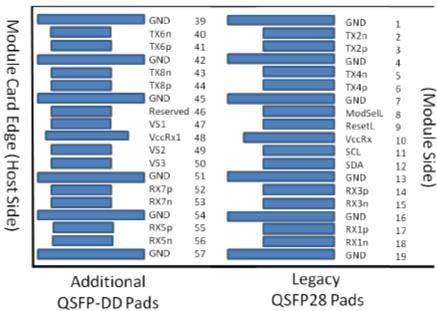
#### Figure 1-1 Transceiver block diagram

#### 2. Pin Descriptions

Figure 2-1 MSA compliant connector

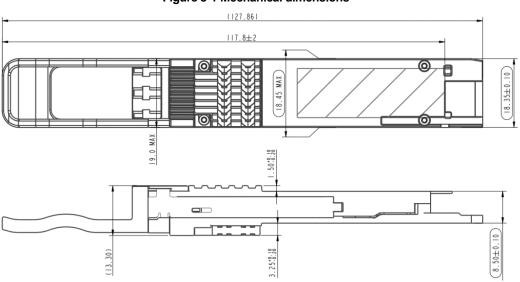


#### Top side viewed from top



Bottom side viewed from bottom

### 3. Mechanical Specifications



### Figure 3-1 Mechanical dimensions

### 4. Ordering Information

Part Number	Description
OM9660LS100	400GBASE-LR8 QSFP-DD, Pull-tap, Single rate

#### Copyright © HiSilicon Optoelectronics Co., Ltd. 2022. All rights reserved.

No part of this document may be reproduced or transmitted in any form or by any means without prior written consent of HiSilicon Optoelectronics Co., Ltd.

#### **Trademarks and Permissions**

Content of HiSilicon Optoelectronics Co., Ltd.

All other trademarks and trade names mentioned in this document are the property of their respective holders.

#### Notice

The purchased products, services and features are stipulated by the contract made between HiSilicon Optoelectronics Co., Ltd. and the customer. All or part of the products, services and features described in this document may not be within the purchase scope or the usage scope. Unless otherwise specified in the contract, all statements, information, and recommendations in this document are provided "AS IS" without warranties, guarantees or representations of any kind, either express or implied.

The information in this document is subject to change without notice. Every effort has been made in the preparation of this document to ensure accuracy of the contents, but all statements, information, and recommendations in this document do not constitute a warranty of any kind, express or implied.